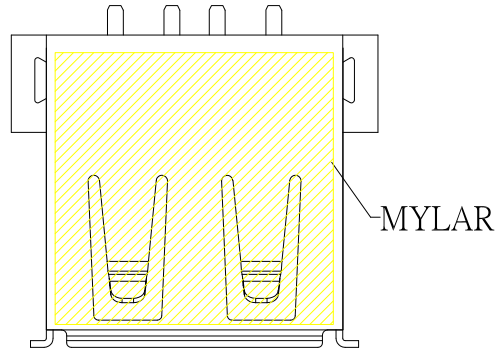
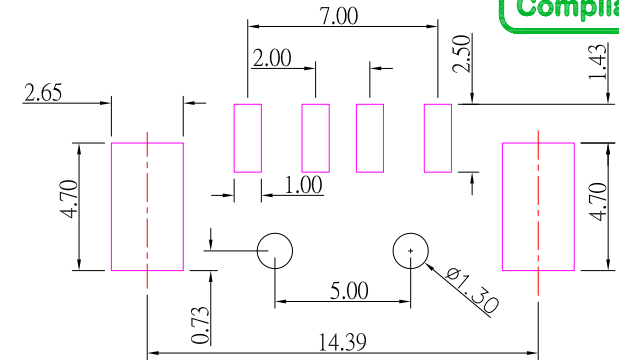
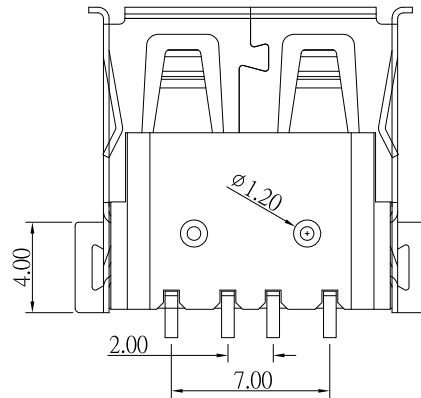
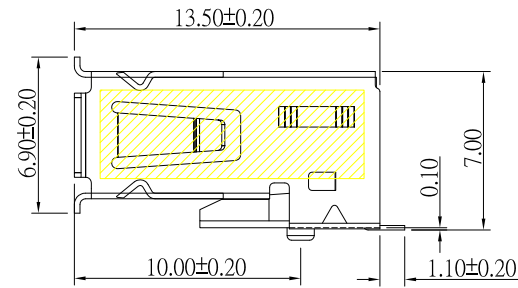
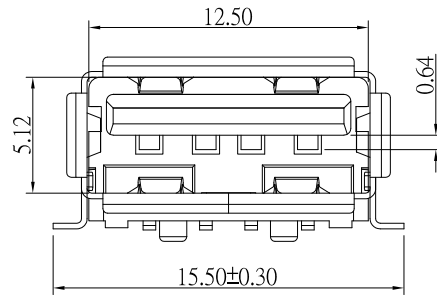
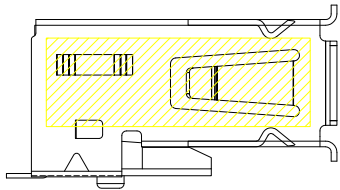


SUA-110M11C-x-S165

Color :
White : W
Black : B



MYLAR



PCB LAYOUT

SPECIFICATIONS

Electrical:

- 1.Current Rating: 1.5 AMP
- 2.Contact Resistance: 30 mΩ Max
- 3.Insulation Resistance: 1,000 MΩ Min
- 4.Dielectric Withstanding Voltage: 500 V AC

Material:

- 1.Housing: LCP
- 2.Contact: Brass
- 3.Shell: Brass

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

 东莞市高迪电子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS
OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°

3RD.
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu
CHECKED BY: Jacky Chen
APPROVED BY: Tony Kao

DATE: 06/03/21
DATE: 06/03/21
DATE: 06/03/21

MAT'L
FINISH
SCALE
SHEET NO.

1 : 1
1 of 1

TITLE: CONNECTOR
MODLE: USB AF 方耳 柱1.2 柱距5.0
DWG NO.: SUA-110M11C-x-S165
PART NO.: SUA-110M11C-x-S165

SIZE: A4
VER: R